



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Box Non-Fee Amendment
Commissioner of Patents
Washington, D.C. 20231

2812

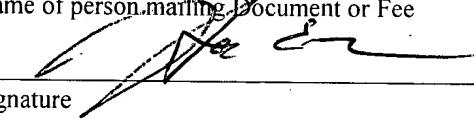
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I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Box Non-Fee Amendment, Commissioner of Patents, Washington, D.C. 20231 on April 7, 2003

(Date of Deposit)

Harold C. Moore

Name of person mailing Document or Fee


Signature

April 7, 2003

Date of Signature

Re: Application of: Newell E. Chiesl
Serial No.: 09/960,441
Filed: September 21, 2001
Confirmation No.: 5776
For: Arrangement for Measuring Pressure on a
Semiconductor Wafer and an Associated
Method for Fabricating a Semiconductor
Wafer
Group Art Unit: 2812
Examiner: Viktor Simkovic
Our Docket No.: 1003-0610

**TRANSMITTAL OF RESPONSE TO NOTICE OF NON-COMPLIANT
AMENDMENT**

Please find for filing in connection with the above patent application the following:

1. Response to Notice of Non-Compliant Amendment; and
2. One (1) Return Post Card.

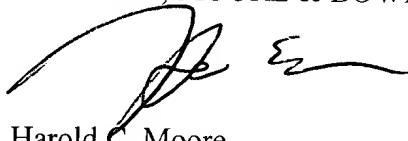
* The fee has been calculated as shown below.

CLAIMS AS AMENDED				
	Claims Remaining After Amendment	Highest No. Paid For	Fee Calculation	Addit Fee
Total Claims	11	20	0 X 18	\$ 0.00
Independent Claims	2	3	0 X 84	\$ 0.00
Total Additional Fee Required				\$ 0.00

Please charge any fee deficiency, or credit any overpayment, to Deposit Account No. 13-0014; but not to include any payment of issue fees.

Respectfully Submitted,

MAGINOT, MOORE & BOWMAN



April 7, 2003

Harold C. Moore
Registration No. 37,892
Bank One Center/Tower
111 Monument Circle, Suite 3000
Indianapolis, Indiana 46204-5115

Enclosures